Massachusetts Institute of Technology 3.155J / 6.152J Micro/Nano Processing Technology Fall Term 2005

Problem Set 6: Lithography, etc.

Out: November 4, 2005 Due: November 9, 2005

- 1) Calculate and plot versus exposure wavelength the theoretical resolution and depth of focus for a projection exposure system with an NA of 0.6 (about the best that can be done today). Assume k1 = 0.6 and k2 = 0.5. Consider wavelengths between 100nm and 1000nm. Indicate the common exposure wavelengths being used or considered (i-ling, g-line, KrF, ArF). Will an ArF source be adequate for 0.13 and 0.1 micron IC technologies according to these calculations?
- 2) Calculate the CMTF for AZ-1450 (a resist with specs listed below) at four wavelengths. Assuming NA = 0.4, use the figure below to determine the minimum linewidth for an aligner with S = 0.5 using this resist at various wavelengths. The figure below plots MTF of the aligner for a set of lines and spaces. The lines and spaces are of equal width (W), and the spatial frequency is normalized by the Rayleigh criteria, R. In other words, a normalized spatial frequency of 0.5, corresponds to a linewith W equal to R (since the equivalent source spacing of the lines is 2W).

Wavelength (nm)	Contrast of AZ-1450
248	0.7
313	3.4
365	3.6
436	3.6

